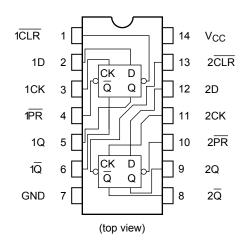
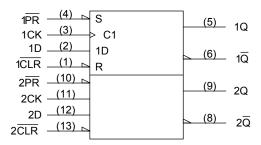
#### **Pin Assignment**



### **IEC Logic Symbol**



#### **Truth Table**

	Inp	uts		Out	puts	Function	
CLR	PR	D	CK	Q	Q	FullClion	
L	Н	Х	Х	L	Н	Clear	
Н	L	Х	Х	Η	L	Preset	
L	L	Х	Х	Н	Н	_	
Н	Н	L		L	Н	_	
Н	Н	Н		Н	L	_	
Н	Н	Х	$\Box$	Qn	$\overline{Q}_n$	No Change	

X: Don't care

### **Absolute Maximum Ratings (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	-0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	-0.5 to 7.0	V
DC output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	lık	-20	mA
Output diode current	lok	±20	mA
DC output current	lout	±25	mA
DC V <sub>CC</sub> /ground current	Icc	±50	mA
Power dissipation	PD	180	mW
Storage temperature	T <sub>stg</sub>	−65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).



# **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit	
Supply voltage	V <sub>CC</sub>	2.0 to 5.5	V	
Input voltage	V <sub>IN</sub>	0 to 5.5	V	
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	V	
Operating temperature	T <sub>opr</sub>	−40 to 85	°C	
Input rise and fall time	dt/dv	0 to 100 (V <sub>CC</sub> = 3.3 ± 0.3 V)	ns/V	
input rise and rail time	ui/uv	0 to 20 (V <sub>CC</sub> = 5 ± 0.5 V)		

Note: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either VCC or GND.

#### **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Symbol	Test Condition V <sub>CC</sub> (			Ta = 25°C			Ta = -40 to 85°C		Unit
				V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
High-level input		_		2.0	1.50	_	_	1.50	_	V
voltage	V <sub>IH</sub>			3.0 to 5.5	V <sub>CC</sub> × 0.7	_	_	V <sub>CC</sub> × 0.7	_	
Low-level input				2.0	_	_	0.50	_	0.50	
voltage	$V_{IL}$		_	3.0 to 5.5	_	_	V <sub>CC</sub> × 0.3	_	V <sub>CC</sub> × 0.3	V
	Voн			2.0	1.9	2.0	_	1.9	_	
		V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -50 μA	3.0	2.9	3.0	_	2.9	_	
High-level output voltage				4.5	4.4	4.5	_	4.4	_	V
Ŭ			I <sub>OH</sub> = -4 mA	3.0	2.58		_	2.48	_	
			I <sub>OH</sub> = -8 mA	4.5	3.94	1	_	3.80	1	
	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>		2.0	-	0.0	0.1	_	0.1	
			I <sub>OL</sub> = 50 μA	3.0	_	0.0	0.1	_	0.1	
Low-level output voltage				4.5	_	0.0	0.1	_	0.1	V
			I <sub>OL</sub> = 4 mA	3.0	_	_	0.36	_	0.44	
			I <sub>OL</sub> = 8 mA	4.5	_	-	0.36	_	0.44	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5	_	_	±0.1	-	±1.0	μΑ
Quiescent supply current	Icc	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	_	_	2.0	_	20.0	μΑ



### Timing Requirements (input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	Ta = 25°C	Ta = -40 to 85°C	Unit	
			V <sub>CC</sub> (V)	Limit	Limit	
Minimum pulse width	t <sub>w (L)</sub>		$3.3 \pm 0.3$	6.0	7.0	no
(CK)	t <sub>w (H)</sub>	_	$5.0 \pm 0.5$	5.0	5.0	ns
Minimum pulse width	4		$3.3 \pm 0.3$	6.0	7.0	20
(CLR, PR)	t <sub>w (L)</sub>	_	$5.0 \pm 0.5$	5.0	5.0	ns
Minimum act un time	t <sub>s</sub>		$3.3 \pm 0.3$	6.0	7.0	ns
Minimum set-up time			$5.0 \pm 0.5$	5.0	5.0	
Minimum hold time	4.		$3.3 \pm 0.3$	0.5	0.5	20
Minimum hold time	t <sub>h</sub>	_	$5.0 \pm 0.5$	0.5	0.5	ns
Minimum removal time	4		$3.3 \pm 0.3$	5.0	5.0	20
(CLR, PR)	t <sub>rem</sub>	_	$5.0 \pm 0.5$	3.0	3.0	ns

### AC Characteristics (input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit	
	- ,		V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Тур.	Max	Min	Max	
			$3.3 \pm 0.3$	15	_	6.7	11.9	1.0	14.0	
Propagation delay time	t <sub>pLH</sub>	_	3.3 ± 0.3	50	_	9.2	15.4	1.0	17.5	ns ns
(CK-Q, $\overline{Q}$ )	$t_{pHL}$		5.0 ± 0.5	15	_	4.6	7.3	1.0	8.5	
			3.0 ± 0.3	50	_	6.1	9.3	1.0	10.5	
	t <sub>pLH</sub>	_	3.3 ± 0.3	15	_	7.6	12.3	1.0	14.5	- ns
Propagation delay time				50	_	10.1	15.8	1.0	18.0	
$(\overline{CLR},\overline{PR}-Q,\overline{Q})$			5.0 ± 0.5	15	_	4.8	7.7	1.0	9.0	
				50	_	6.3	9.7	1.0	11.0	
	f <sub>max</sub>	-	3.3 ± 0.3	15	80	125	_	70	_	
Maximum clock				50	50	75	_	45	_	MHz
frequency			5.0 ± 0.5	15	130	170	_	110	_	IVII IZ
				50	90	115	_	75	_	
Input capacitance	C <sub>IN</sub>		_		_	4	10	_	10	pF
Power dissipation capacitance	C <sub>PD</sub>			(Note)	_	25	_	_	_	pF

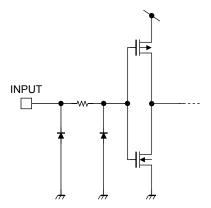
Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/2 (per F/F)$ 



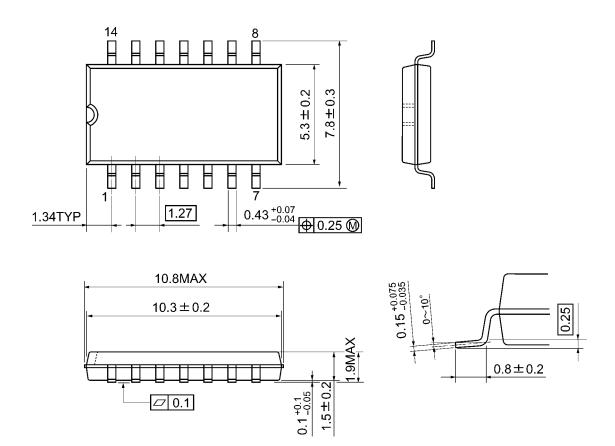
# **Input Equivalent Circuit**





### **Package Dimensions**

SOP14-P-300-1.27A Unit: mm

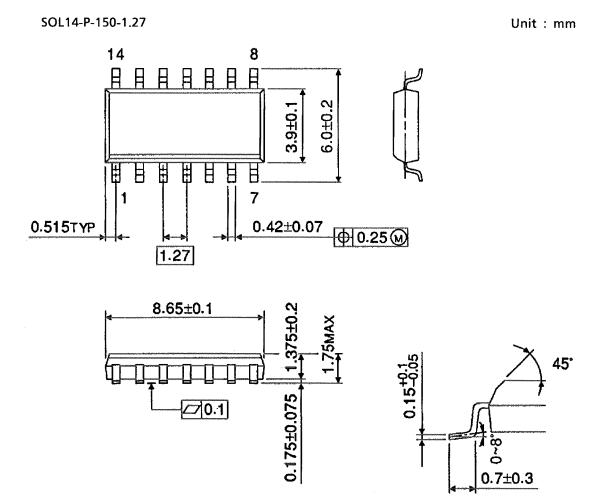


6

Weight: 0.18 g (typ.)



# **Package Dimensions (Note)**



Note: This package is not available in Japan.

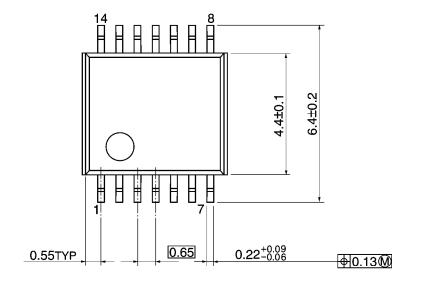
Weight: 0.12 g (typ.)

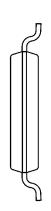


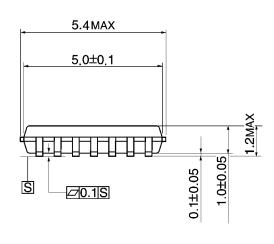
### **Package Dimensions**

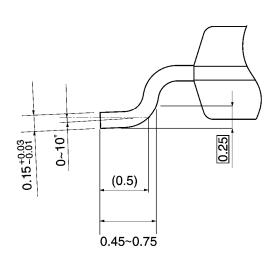
TSSOP14-P-0044-0.65A

Unit: mm





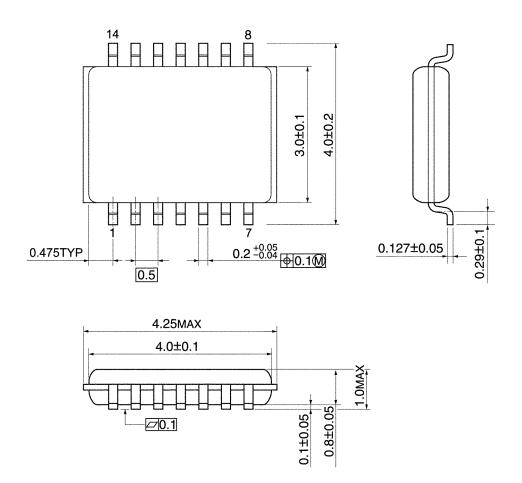




Weight: 0.06 g (typ.)

### **Package Dimensions**

VSSOP14-P-0030-0.50 Unit: mm



Weight: 0.02 g (typ.)

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